



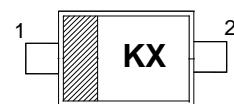
迈拓电子
MAITUO ELECTRONIC

1N4010WT Schottky Diode

- ◇ Low Forward Voltage Drop
- ◇ SOD523 Micro SMD package
- ◇ RoHS compliant / Green EMC
- ◇ Matte Tin (Sn) Lead finish
- ◇ Cathode Band / Device marking
- ◇ Surface Mount Package Ideally Suited for Automatic Insertion

Marking KX

Cathode Anode



SOD-523

Maximum Ratings ($T_a = 25 \text{ }^{\circ}\text{C}$)

Symbol	Parameter	Value	Units
V_{RRM}	Repetitive Peak Reverse Voltage	40	V
$I_{F(AV)}$	Average Forward Rectified Current	1	A
I_{FSM}	Non-Repetitive Peak Forward Surge Current (@t=8..3ms)	6	A
T_J	Operating Junction Temperature	125	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-50 to +125	$^{\circ}\text{C}$

Electrical Characteristics ($T_a = 25 \text{ }^{\circ}\text{C}$)

Symbol	Parameter	Conditions	Min	Max	Units
V_F	Forward Voltage	$I_F = 0.3\text{A}$		0.5	V
		$I_F = 1\text{A}$		0.8	V
I_R	Reverse current	$V_R = 40\text{V}$		100	uA
V_{BR}	Reverse breakdown voltage	$I_R = 0.5\text{mA}$	40		V
C_T	Capacitance	$V_R = 0\text{V}, f = 1\text{MHz}$		100	pF



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Fig. 1 - Forward Current Derating Curve

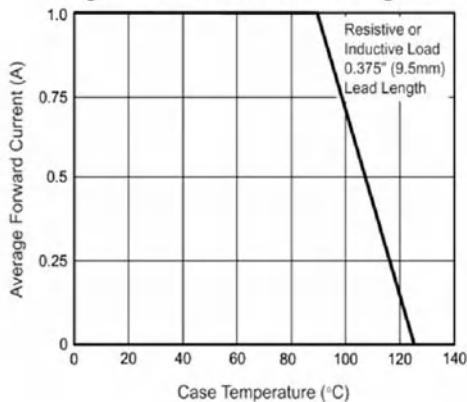


Fig. 3 - Typical Instantaneous Forward Characteristics

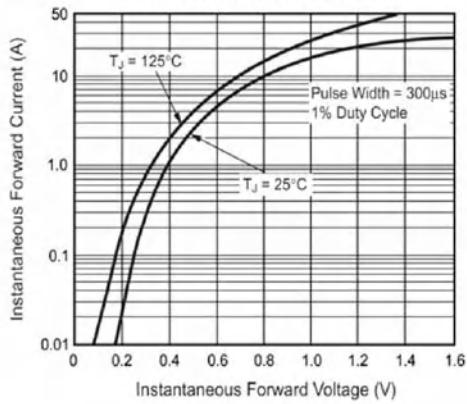


Fig. 5 - Typical Junction Capacitance

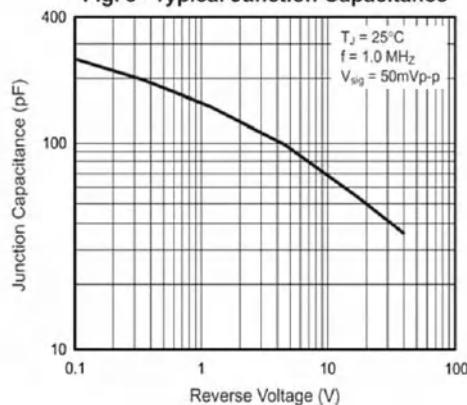


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

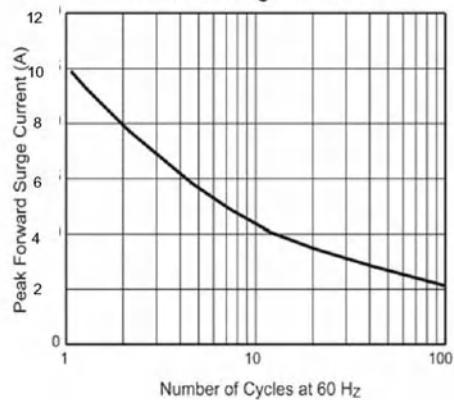


Fig. 4 - Typical Reverse Characteristics

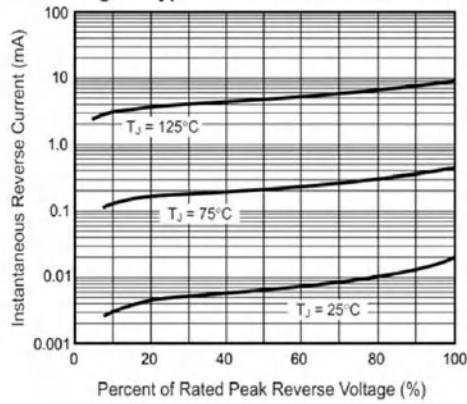
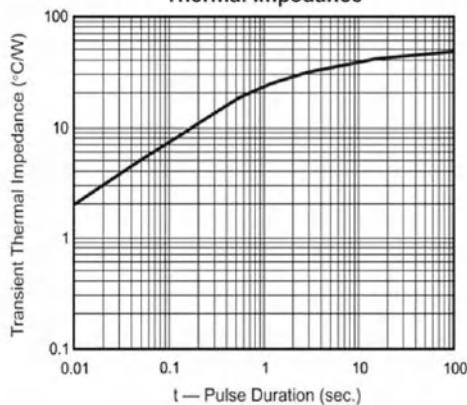


Fig. 6 - Typical Transient Thermal Impedance



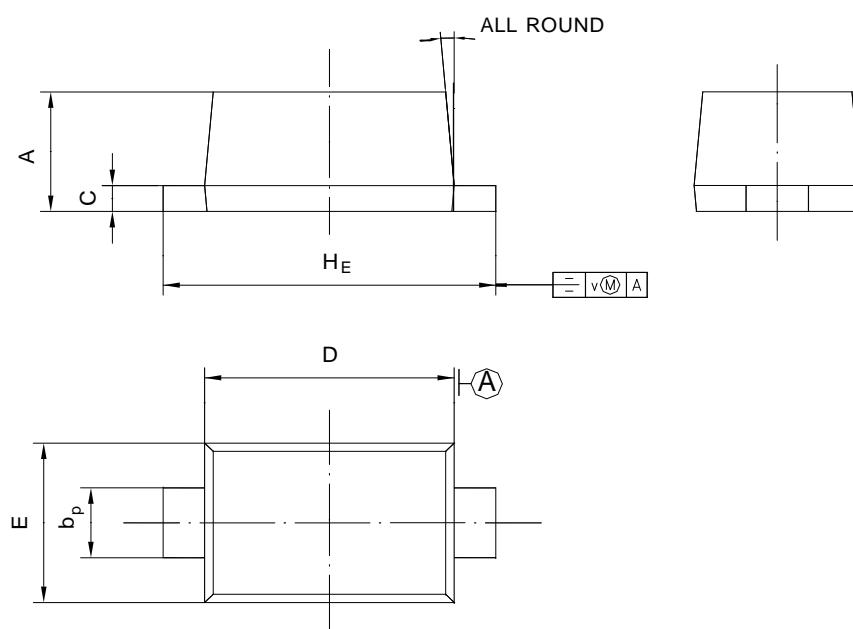


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PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-523



UNIT	A	b _p	C	D	E	H _E	V	∠
mm	0.68 0.58	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°